

200mA, SMD Switching Diode

FEATURES

- Designed for mounting on small surface
- Low Capacitance
- Low forward voltage drop
- Moisture sensitivity level: level 1, per J-STD-020
- Compliant to RoHS directive 2011/65/EU and in accordance to WEEE 2002/96/EC
- Halogen-free according to IEC 61249-2-21

| KEY PARAMETERS | | | |
|--|--------|------|--|
| PARAMETER | VALUE | UNIT | |
| I _F | 200 | mA | |
| V_{RRM} | 100 | > | |
| I _{FSM} | 2 | Α | |
| V _F at I _F =10mA | 1 | V | |
| T _J Max. | 150 | °C | |
| Package | SOT-23 | | |

APPLICATIONS

- Switching mode power supply (SMPS)
- Adapters
- Lighting application
- On-board DC/DC converter



MECHANICAL DATA

- Case: SOT-23
- Molding compound meets UL 94 V-0 flammability rating
- Terminal: Matte tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 1A whisker test
- Weight: 8 mg (approximately)



| ABSOLUTE MAXIMUM RATINGS (T _A = 25°C un PARAMETER | | SYMBOL | VALUE | UNIT | | |
|---|------------|------------------|-------------|------|-------|--|
| MMBD4148 | |)4148 | OT III DOL | 5D | OIIII | |
| Marking code on the device | MMBD4148CA | | | A1 | | |
| | MMBD4148CC | | | A4 | | |
| | MMBD4148SE | | | A7 | | |
| Repetitive peak reverse voltage | | V_{RRM} | 100 | V | | |
| Forward current | | I _F | 200 | mA | | |
| Repetitive peak forward surge current | | I _{FRM} | 700 | mA | | |
| Non-repetitive peak forward surge current at t=1µs at t=1s | | at t=1µs | 1 | 2 | | |
| | | I _{FSM} | 1 | - A | | |
| Junction temperature range | | T _J | -55 to +150 | °C | | |
| Storage temperature range | | T _{STG} | -55 to +150 | °C | | |

Taiwan Semiconductor

| THERMAL PERFORMANCE | | | | |
|--|-----------------|-----|------|--|
| PARAMETER | SYMBOL | TYP | UNIT | |
| Junction-to-ambient thermal resistance | $R_{\Theta JA}$ | 357 | °C/W | |

| ELECTRICAL SPECIFICATIONS (T _A = 25°C unless otherwise noted) | | | | | |
|---|--|-----------------|-----|------|------|
| PARAMETER | CONDITIONS SYMBOL | | MIN | MAX | UNIT |
| Forward voltage per diode (1) | I _F = 10mA, T _J = 25°C | V _F | - | 1.0 | V |
| Reverse current @ rated V _R per diode ⁽²⁾ | V _R = 20V ,T _J = 25°C | | - | 25.0 | nA |
| | V _R = 75V ,T _J = 25°C | I _R | - | 5.0 | μΑ |
| | V _R = 20V ,T _A = 150°C | | - | 50.0 | |
| December 1 | I _R = 5μA ,T _J = 25°C | ., | 75 | - | V |
| Reverse breakdown voltage | I _R = 100μA ,T _J = 25°C | $V_{(BR)}$ | 100 | - | |
| Junction capacitance | 1 MHz, V _R =0V | CJ | - | 4.0 | pF |
| Reverse recovery time | I_F =10mA, I_R =1mA, R_L =100Ω, V_R =6V | t _{rr} | - | 4.0 | ns |

Notes:

- 1. Pulse test with PW=0.3 ms
- 2. Pulse test with PW=30 ms

| ORDERING INFORMATION | | | |
|---------------------------|---------|----------------|--|
| ORDERING CODE (Note 1) | PACKAGE | PACKING | |
| MMBD414xx RFG | SOT-23 | 3K / 7" Reel | |
| MMBD414xx R5G | SOT-23 | 10K / 13" Reel | |

Note:

1. "xx" defines part no. from "8" to "8SE"



CHARACTERISTICS CURVES

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$

Fig. 1 Power Derating Curve

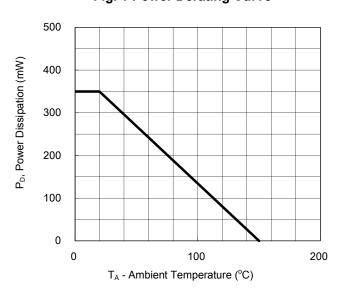


Fig.2 Forward Characteristics

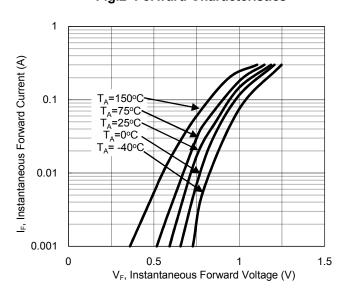


Fig.3 Typical Reverse Characteristics

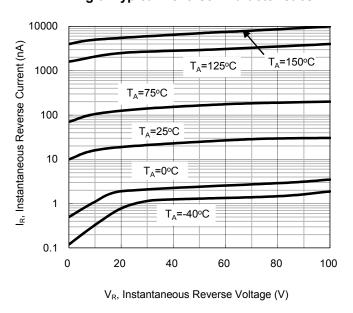
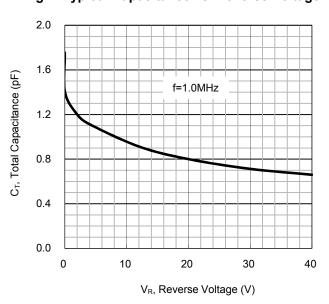


Fig.4 Typical Capacitance vs. Reverse Voltage

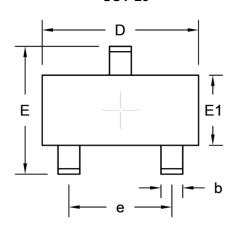


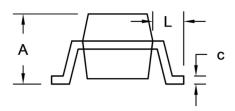


Taiwan Semiconductor

PACKAGE OUTLINE DIMENSION

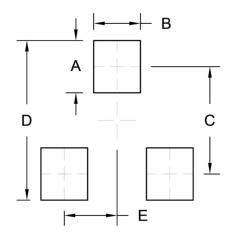
SOT-23





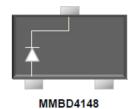
| DIM. | Unit (mm) | | Unit (| (inch) |
|------|-----------|------|------------|--------|
| DIW. | Min. | Max. | Min. | Max. |
| Α | 0.89 | 1.30 | 0.035 | 0.051 |
| b | 0.30 | 0.51 | 0.012 | 0.020 |
| С | 0.10 REF. | | 0.004 REF. | |
| D | 2.70 | 3.10 | 0.106 | 0.122 |
| E | 2.10 | 2.64 | 0.083 | 0.104 |
| E1 | 1.10 | 1.50 | 0.043 | 0.059 |
| е | 1.78 | 2.04 | 0.070 | 0.080 |
| L | 0.55 | REF. | 0.022 | REF. |

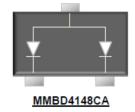
SUGGEST PAD LAYOUT

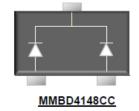


| Symbol | Unit (mm) | Unit (inch) |
|--------|-----------|-------------|
| Α | 0.95 | 0.037 |
| В | 0.85 | 0.033 |
| С | 1.95 | 0.077 |
| D | 2.90 | 0.114 |
| E | 0.96 | 0.038 |

PIN CONFIGURATION











Taiwan Semiconductor

Notice

Specifications of the products displayed herein are subject to change without notice. TSC or anyone on its behalf, assumes no responsibility or liability for any errors or inaccuracies.

Purchasers are solely responsible for the choice, selection, and use of TSC products and TSC assumes no liability for application assistance or the design of Purchasers' products.

Information contained herein is intended to provide a product description only. No license, express or implied, to any intellectual property rights is granted by this document. Except as provided in TSC's terms and conditions of sale for such products, TSC assumes no liability whatsoever, and disclaims any express or implied warranty, relating to sale and/or use of TSC products including liability or warranties relating to fitness for a particular purpose, merchantability, or infringement of any patent, copyright, or other intellectual property right.

The products shown herein are not designed for use in medical, life-saving, or life-sustaining applications. Customers using or selling these products for use in such applications do so at their own risk and agree to fully indemnify TSC for any damages resulting from such improper use or sale.